



DUAL N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
50V	3.5Ω @ V _{GS} = 10V	200mA

Description

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

Load Switch



TOP VIEW

Features

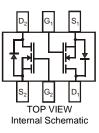
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at https://www.diodes.com/products/automotive/automotive-

products/.

- This part is qualified to JEDEC standards (as references in AEC-Q101) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (BSS138DWQ)

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.006 grams (approximate)



Ordering Information (Note 4)

	Part Number	Case	Packaging			
	BSS138DW-7-F	SOT-363	3000/Tape & Reel			
Notes:	1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

K38	Ϋ́Μ	K38	YM
MY	K38	MY	K38

K38 = Product Type Marking Code

YM = Date Code Marking for SAT (Shanghai Assembly/ Test site) YM = Date Code Marking for CAT (Chengdu Assembly/ Test site) Y or \overline{Y} = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Year	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019
Code	S	Т	U	V	W	Х	Y	Z	А	В	С	D	E	F	G
Month	Jan	Fel	b I	/ ar	Apr	May	Jur	۱ I	Jul	Aug	Sep	Oc	t I	lov	Dec
Code	1	2		3	4	5	6		7	8	9	0		Ν	D



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	C	Symbol	BSS138DW	Units
Drain-Source Voltage		V _{DSS}	50	V
Drain-Gate Voltage (Note 7)		V _{DGR}	50	V
Gate-Source Voltage	Continuous	V _{GSS}	±20	V
Drain Current (Note 5)	Continuous	ID	200	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	BSS138DW	Units
Total Power Dissipation (Note 5)	PD	200	mW
Thermal Resistance, Junction to Ambient	R _{0JA}	625	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)						·	
Drain-Source Breakdown Voltage	BV _{DSS}	50	75	_	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_		0.5	μA	$V_{DS} = 50V, V_{GS} = 0V$	
Gate-Body Leakage	I _{GSS}	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)						·	
Gate Threshold Voltage	V _{GS(th)}	0.5	1.2	1.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	R _{DS (ON)}	_	1.4	3.5	Ω	$V_{GS} = 10V, I_D = 0.22A$	
Forward Transconductance	G FS	100		_	mS	V _{DS} =25V, I _D = 0.2A, f = 1.0KHz	
DYNAMIC CHARACTERISTICS						• -	
Input Capacitance	C _{iss}	_	_	50	pF		
Output Capacitance	Coss			25	pF	$V_{DS} = 10V, V_{GS} = 0V, f = 1.0MHz$	
Reverse Transfer Capacitance	Crss			8.0	pF	1	
SWITCHING CHARACTERISTICS						•	
Turn-On Delay Time	t _{D(ON)}			20	ns	$V_{DD} = 30V, I_D = 0.2A,$	
Turn-Off Delay Time	t _{D(OFF)}	_		20	ns	$R_{GEN} = 50\Omega$	

Notes: Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found 5. on our website at http://www.diodes.com/package-outlines.html. Short duration pulse test used to minimize self-heating effect.

6.

 $7. \quad R_{GS} \leq 20 K \Omega.$



T_i = 25℃

 $V_{GS} = 3.5V$

V_{GS} = 3.25V

 $V_{GS} = 3.0V$

V_{GS} = 2.75V

V_{GS} = 2.5V

9 10

0.6

0.5

0.4

0.3

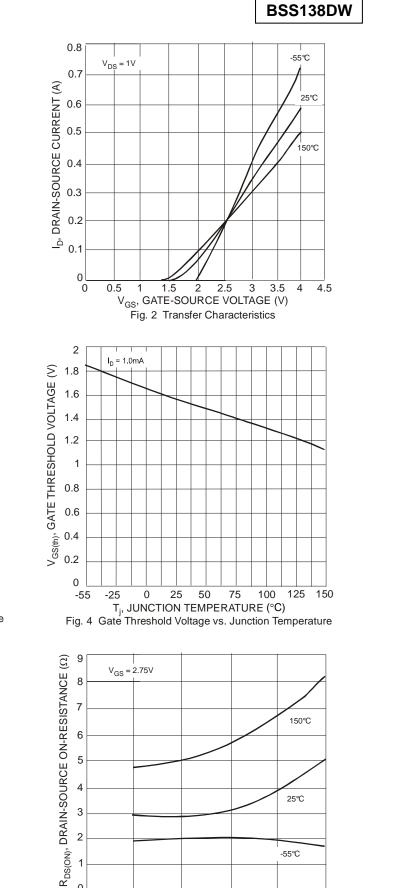
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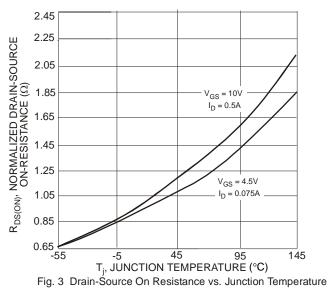
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0

0 1

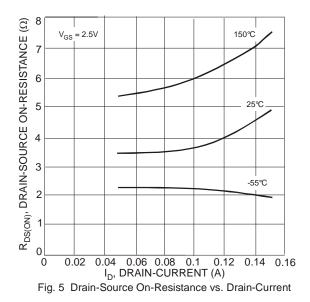
ID, DRAIN-SOURCE CURRENT (A)





2 3 4 5 6 7 8 V_{DS}, DRAIN-SOURCE VOLTAGE (V)

Fig. 1 Drain-Source Current vs. Drain-Source Voltage



0

ō

0.05

0.1

I_D, DRAIN-CURRENT (A)

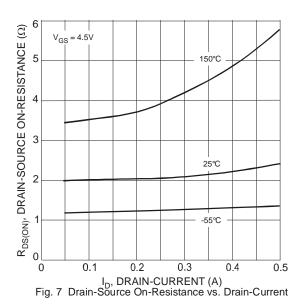
Fig. 6 Drain-Source On-Resistance vs. Drain-Current

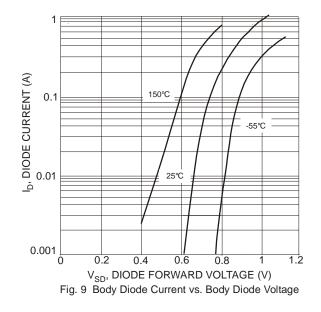
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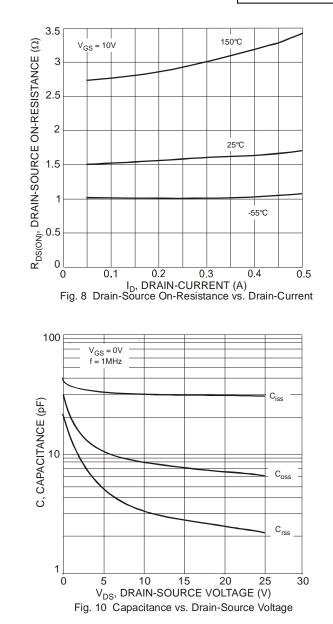
0.2

0.25





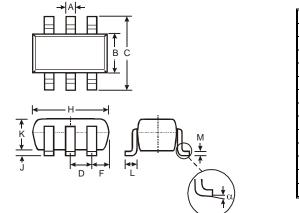






Package Outline Dimensions

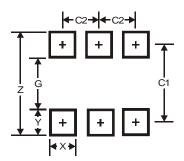
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT363								
Dim	Min	Max	Тур					
Α	0.10	0.30	0.25					
В	1.15	1.35	1.30					
S	2.00	2.20	2.10					
D		0.65 Ty	р					
н	0.40	0.45	0.425					
H	1.80	2.20	2.15					
L	0	0.10	0.05					
Κ	0.90	1.00	1.00					
L	0.25	0.40	0.30					
Μ	0.10	0.22	0.11					
α	0°	8°	-					
All	Dimen	sions i	n mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Y	0.6
C1	1.9
C2	0.65



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